

PSMN7R0-100XS

N-channel 100V 6.8 m Ω standard level MOSFET in TO220F (SOT186A)

Rev. 3 — 6 March 2012

Product data sheet

Product profile 1.

1.1 General description

Standard level N-channel MOSFET in TO220F (SOT186A) package qualified to 175C. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

High efficiency due to low switching and conduction losses

1.3 Applications

- AC-to-DC power supply equipment
- Motor control

1.4 Quick reference data

- Isolated package
- Suitable for standard level gate drive
- Server power supplies
- Synchronous rectification

Table 1.	Quick reference data					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	-	100	V
I _D	drain current	T_{mb} = 25 °C; V_{GS} = 10 V; see <u>Figure 1</u>	-	-	55	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>	-	-	57.7	W
Static cha	aracteristics					
R_{DSon}	drain-source on-state resistance	V _{GS} = 10 V; I _D = 15 A; T _j = 25 °C; see <u>Figure 12</u> ; see <u>Figure 13</u>	-	5.4	6.8	mΩ
Dynamic	characteristics					
Q _{GD}	gate-drain charge	V_{GS} = 10 V; I_{D} = 15 A; V_{DS} = 50 V;	-	34	-	nC
Q _{G(tot)}	total gate charge	see Figure 14; see Figure 15	-	121	-	nC
Avalanch	e ruggedness					
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	$ V_{GS} = 10 \text{ V}; \text{T}_{j(init)} = 25 \text{ °C}; \text{I}_{\text{D}} = 55 \text{ A}; \\ V_{sup} \leq 100 \text{ V}; \text{ unclamped}; \text{R}_{\text{GS}} = 50 \Omega; \\ see \underline{\text{Figure 3}} $	-	-	420	mJ



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2. Pinning information

Table 2.	Pinning	j information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	G	gate		-
2	D	drain	mb	D
3	S	source		
mb		mounting base; isolated		mbb076 S

SOT186A (TO-220F)

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PSMN7R0-100XS	TO-220F	plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 "full pack"	SOT186A

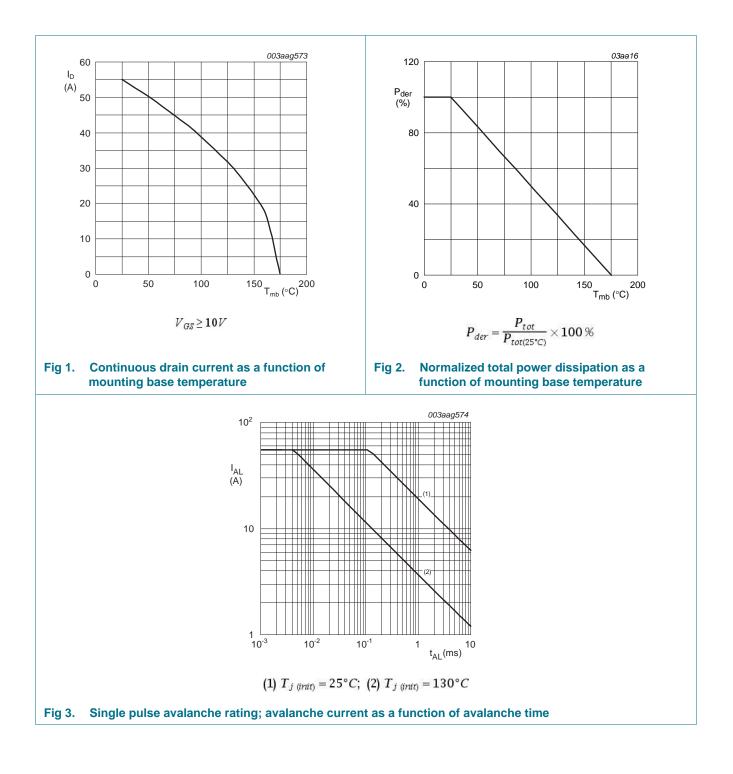
4. Limiting values

Table 4.Limiting values

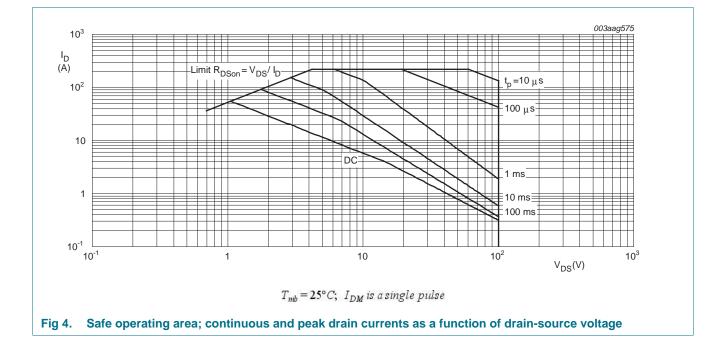
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DS}	drain-source voltage	T _j ≥ 25 °C; T _j ≤ 175 °C	-	100	V
V _{DGR}	drain-gate voltage	$T_j \ge 25 \text{ °C}; T_j \le 175 \text{ °C}; R_{GS} = 20 \text{ k}\Omega$	-	100	V
V _{GS}	gate-source voltage		-20	20	V
I _D	drain current	V _{GS} = 10 V; T _{mb} = 25 °C; see <u>Figure 1</u>	-	55	А
		V _{GS} = 10 V; T _{mb} = 100 °C; see <u>Figure 1</u>	-	38.9	А
I _{DM}	peak drain current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$; see Figure 4	-	220	А
P _{tot}	total power dissipation	T _{mb} = 25 °C; see <u>Figure 2</u>	-	57.7	W
T _{stg}	storage temperature		-55	175	°C
Tj	junction temperature		-55	175	°C
T _{sld(M)}	peak soldering temperature		-	260	°C
Source-dra	ain diode				
Is	source current	T _{mb} = 25 °C	-	48	А
I _{SM}	peak source current	pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$	-	220	А
Avalanche	ruggedness				
E _{DS(AL)S}	non-repetitive drain-source avalanche energy	V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_D = 55 A; $V_{sup} \le$ 100 V; unclamped; R_{GS} = 50 Ω ; see <u>Figure 3</u>	-	420	mJ
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5. Thermal characteristics

Thermal characteristics

Table 5.	I nermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	see Figure 5	-	2.35	2.6	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	vertical in free air	-	55	-	K/W

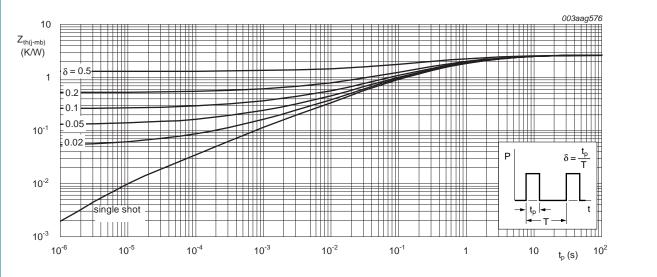


Fig 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

6. Isolation characteristics

Table 6.	Isolation characteristics						
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
C _{isol}	isolation capacitance		[1]	-	10	-	pF
V _{isol(RMS)}	RMS isolation voltage	50 Hz \leq f \leq 60 Hz; RH \leq 65 %; sinusoidal waveform: clean and dust free		-	-	2500	V

[1] f = 1 MHz

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7. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
-	racteristics			.76		•
V _{(BR)DSS}	drain-source breakdown voltage	I _D = 250 μA; V _{GS} = 0 V; T _i = 25 °C	100	-	-	V
(010)000		$I_D = 250 \ \mu\text{A}; \ V_{GS} = 0 \ \text{V}; \ T_i = -55 \ \text{°C}$	90	-	-	V
V _{GS(th)}	gate-source threshold voltage	$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C};$ see Figure 10; see Figure 11	2	3	4	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 175 \text{ °C};$ see Figure 10	1	-	-	V
		$I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = -55 \text{ °C};$ see Figure 10	-	-	4.6	V
I _{DSS}	drain leakage current	V_{DS} = 100 V; V_{GS} = 0 V; T_j = 25 °C	-	-	5	μA
		$V_{DS} = 100 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 100 \text{ °C}$	-	-	100	μA
I _{GSS}	gate leakage current	V _{GS} = 20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
		V _{GS} = -20 V; V _{DS} = 0 V; T _j = 25 °C	-	2	100	nA
R _{DSon} drain-s	drain-source on-state resistance	V_{GS} = 10 V; I_D = 15 A; T_j = 25 °C; see Figure 12; see Figure 13	-	5.4	6.8	mΩ
		V_{GS} = 10 V; I_D = 15 A; T_j = 100 °C; see <u>Figure 13</u>	-	9.45	11.9	mΩ
		V _{GS} = 10 V; I _D = 15 A; T _j = 175 °C; see <u>Figure 13</u>	-	15.1	19	mΩ
R _G	internal gate resistance (AC)	f = 1 MHz	-	0.74	-	Ω
Dynamic o	haracteristics					
Q _{G(tot)}	total gate charge	$I_D = 15 \text{ A}; V_{DS} = 50 \text{ V}; V_{GS} = 10 \text{ V};$	-	121	-	nC
Q _{GS}	gate-source charge	see Figure 14; see Figure 15	-	26.3	-	nC
Q _{GS(th)}	pre-threshold gate-source charge		-	11	-	nC
Q _{GS(th-pl)}	post-threshold gate-source charge		-	15.3	-	nC
Q _{GD}	gate-drain charge		-	34	-	nC
V _{GS(pl)}	gate-source plateau voltage	$I_D = 15 \text{ A}; V_{DS} = 50 \text{ V}; \text{ see } \frac{\text{Figure } 14}{\text{Figure } 15}$	-	4.1	-	V
C _{iss}	input capacitance	$V_{DS} = 50 \text{ V}; V_{GS} = 0 \text{ V}; f = 1 \text{ MHz};$ $T_j = 25 \text{ °C}; \text{ see } Figure 16;$ see Figure 17	-	6686	-	pF
C _{oss}	output capacitance	V_{DS} = 50 V; V_{GS} = 0 V; f = 1 MHz; T _j = 25 °C; see <u>Figure 16</u>	-	438	-	pF
Crss	reverse transfer capacitance	$\label{eq:VDS} \begin{array}{l} V_{DS} = 50 \text{ V}; V_{GS} = 0 \text{ V}; \text{f} = 1 \text{MHz}; \\ T_j = 25 ^\circ\text{C}; \text{ see } \underline{\text{Figure 16}}; \\ \text{see } \underline{\text{Figure 17}} \end{array}$	-	272	-	pF
d(on)	turn-on delay time	$V_{DS} = 50 \text{ V}; \text{ R}_{L} = 4 \Omega; \text{ V}_{GS} = 10 \text{ V};$	-	29	-	ns
r	rise time	$R_{G(ext)} = 4.7 \ \Omega; \ T_{j} = 25 \ ^{\circ}C$	-	30	-	ns
d(off)	turn-off delay time		-	94	-	ns
^t f	fall time		-	43	-	ns

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Table 7. Characteristics ...continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Source-di	rain diode					
V_{SD}	source-drain voltage	I _S = 10 A; V _{GS} = 0 V; T _j = 25 °C; see <u>Figure 18</u>	-	0.76	1.2	V
t _{rr}	reverse recovery time	$I_{S} = 10 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s};$	-	64	-	ns
Qr	recovered charge	$V_{GS} = 0 V; V_{DS} = 50 V$	-	167	-	nC

20

16

12

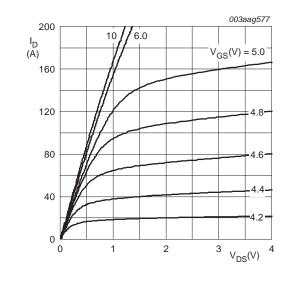
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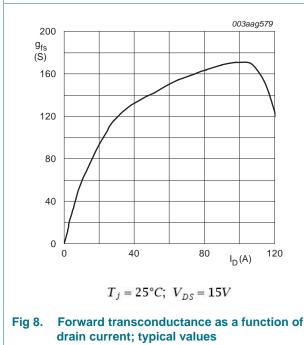
 $\mathsf{R}_{\mathsf{DSon}}$

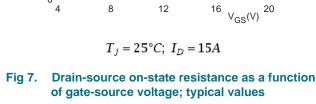
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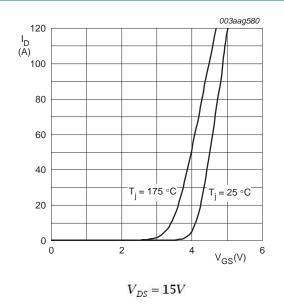






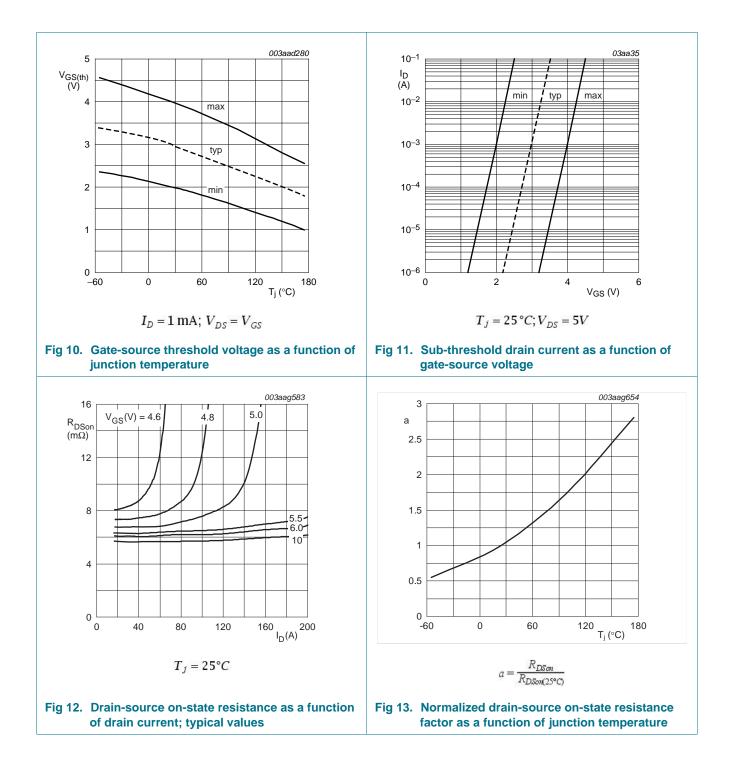




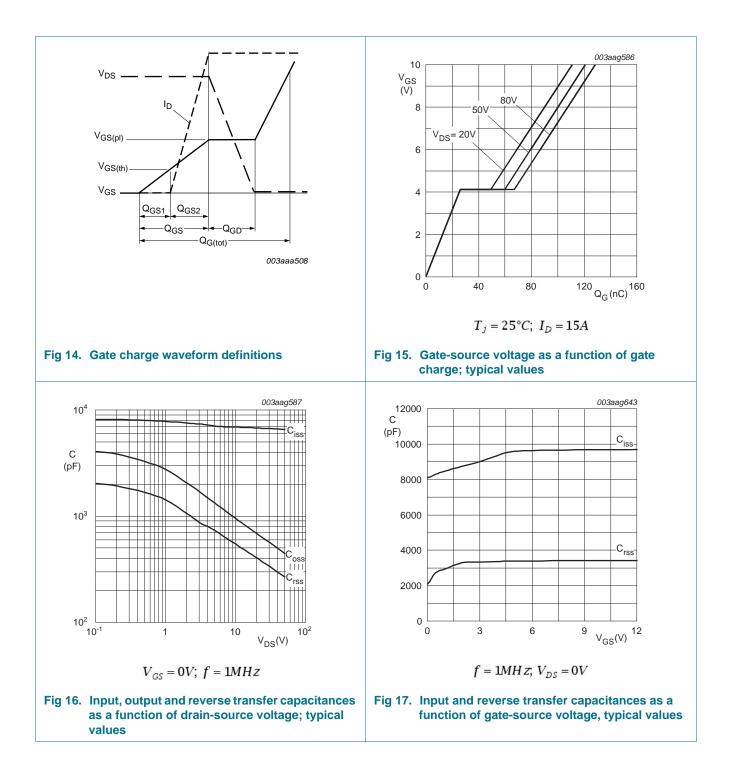




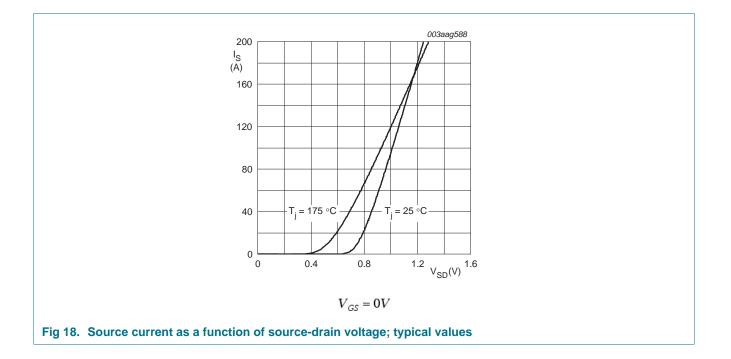
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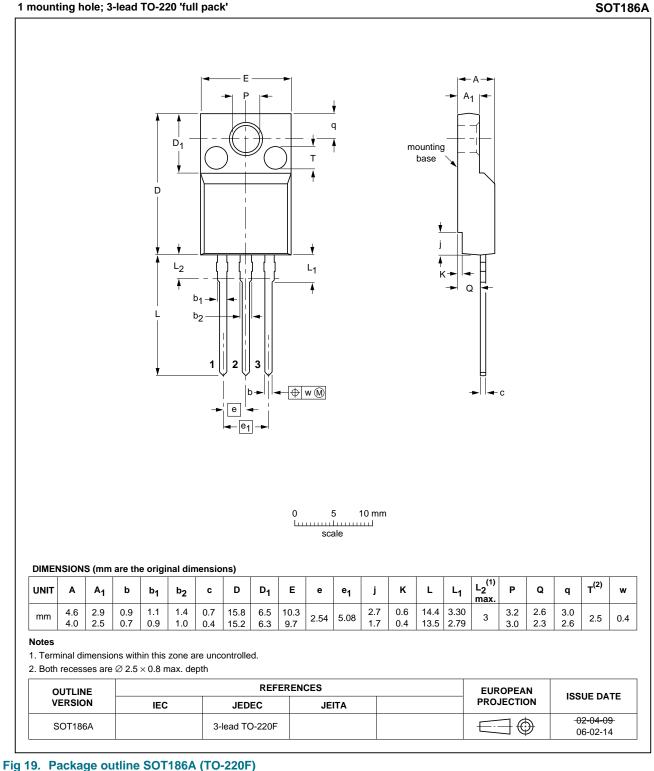
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Package outline 8.



Plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 'full pack'

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9. Revision history

Table 8. Revision h	istory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN7R0-100XS v.3	20120306	Product data sheet	-	PSMN7R0-100XS v.2
Modifications:	 Status changed 	from preliminary to produc	xt.	
	 Various change 	es to content.		
PSMN7R0-100XS v.2	20111021	Preliminary data shee	t -	PSMN7R0-100XS v.1

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10. Legal information

10.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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